

| L Number | Hits | Search Text | DB | Time stamp |
|----------|-------|--|---|---------------------|
| 1 | 39265 | (nickel ni) with (vanadium v) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:54 |
| 2 | 43225 | ((under adj (bump ball)) underball underbump) metallurgy | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:40 |
| 3 | 40496 | (cupper cu wet wettable wett) with (thickness measurement micron) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:52 |
| 4 | 2 | ((nickel ni) with (vanadium v)) same (((under adj (bump ball)) underball underbump) metallurgy) same ((cupper cu wet wettable wett) with (thickness measurement micron)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:54 |
| 5 | 45 | ((nickel ni) with (vanadium v)) and (((under adj (bump ball)) underball underbump) metallurgy) and ((cupper cu wet wettable wett) with (thickness measurement micron)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:44 |
| 6 | 52015 | (cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:56 |
| 7 | 2 | ((nickel ni) with (vanadium v)) same (((under adj (bump ball)) underball underbump) metallurgy) same ((cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:53 |
| 8 | 61036 | (nickel ni) with (vanadium v) niv | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:54 |
| 9 | 3 | ((nickel ni) with (vanadium v) niv) same (((under adj (bump ball)) underball underbump) metallurgy) same ((cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:57 |
| 10 | 52555 | (cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:58 |
| 12 | 98 | ((nickel ni) with (vanadium v) niv) and (((under adj (bump ball)) underball underbump) metallurgy) and ((cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m))) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 11:00 |
| 11 | 3 | ((nickel ni) with (vanadium v) niv) same (((under adj (bump ball)) underball underbump) metallurgy) same ((cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m))) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 11:00 |
| 13 | 52652 | (cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m) mum (mu adj3 m)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 10:59 |

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|----|----|--|---|---------------------|
| 14 | 3 | ((nickel ni) with (vanadium v) niv) same (((under adj (bump ball)) underball underbump) metallurgy) same ((cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m) mum (mu adj3 m))) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 11:01 |
| 15 | 98 | ((nickel ni) with (vanadium v) niv) and (((under adj (bump ball)) underball underbump) metallurgy) and ((cupper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m) mum (mu adj3 m))) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 11:01 |

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| 1 | 39265 | (nickel ni) with (vanadium v) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:38 |
| 2 | 43225 | ((under adj (bump ball)) underball underbump) metallurgy | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:40 |
| 3 | 40496 | (cupper cu wet wettable wett) with (thickness measurement micron) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:41 |
| 4 | 2 | ((nickel ni) with (vanadium v)) same (((under adj (bump ball)) underball underbump) metallurgy) same ((cupper cu wet wettable wett) with (thickness measurement micron)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:44 |
| 5 | 45 | ((nickel ni) with (vanadium v)) and (((under adj (bump ball)) underball underbump) metallurgy) and ((cupper cu wet wettable wett) with (thickness measurement micron)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/25 09:44 |